

Specification for Approval

DEVICE NUMBER: BZ-XZD361-DC13-OP-3%-Q-NC

SAMPLES ATTACHED AREA

PAGE DATE	1	2	3	4	5					CONTENTS
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APPROVED PU	RCHASE MA	ANUFACTURE	QUALITY	ENGINEERING

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ISSUED	APPROVED	PREPARED
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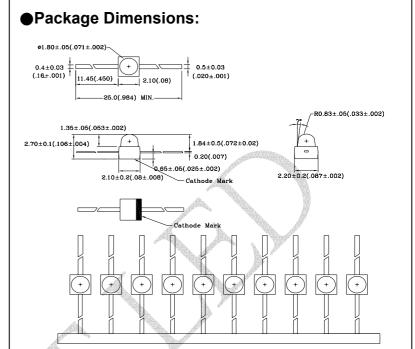
BZ-XZD361-DC13-OP-3%-Q-NC

Features:

- 1. Emitted Color: White.
- 2. Low cost plastic package.
- This product doesn't contain restriction Substance, comply ROHS standard.

Applications:

- 1. Backlighting: LCDs, Key pads advertising.
- Status indicators: Comsumer & industrial electronics.
- 3. General use.



NOTES:

- 1. All dimensions are in millimeters.
- 2. Tolerance is ±0.10mm unless otherwise specified.
- 3. Specifications are subject to change without notice.

■ Absolute Maximum Ratings(Ta=25°C)

Parameter	Symbol	Rating	Unit
Power Dissipation	Pd	70	mW
Forward Current	l _F	20	mA
Peak Forward Current *1	I _{FP}	100	mA
Reverse Voltage	V_R	5	V
Operating Temperature	Topr	-40℃~85℃	-
Storage Temperature	Tstg	-40°C ~85°C	-
Soldering Temperature	Tsol	See Page 4	-

 *1 Condition for I_{FP} is pulse of 1/10 duty and 0.1msec width.



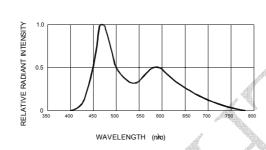
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Electrical and optical characteristics(Ta=25°C)

Parameter	Symbol	Condition	Min.	Тур.	Max.	Unit
Forward Voltage	Vf	IF=20mA		3.2	3.6	V
Luminous Intensity	lv	IF=20mA	94	210		mcd
Reverse Current	I_R	V _R =5V	-	-	1	μΑ
Chromaticity	x	IF=20mA	-	0.31	-	-
Coordinates	у	IF=20mA	-	0.30		-
Viewing Angle	2θ _{1/2}	IF=20mA	-	35	-	deg

Typical Electro-Optical Characteristics Curves

Fig.1 RELATIVE INTENSITY VS. WAVELENGTH



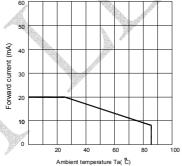


Fig.3 FORWARD CURRENT VS. FORWARD VOLTAGE

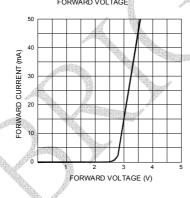


Fig.4 RELATIVE LUMINOUS INTENSITY

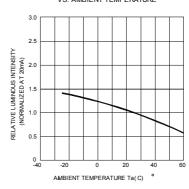


Fig.5 RELATIVE LUMINOUS INTENSITY VS. FORWARD CURRENT

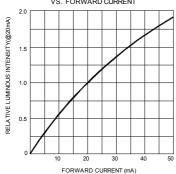
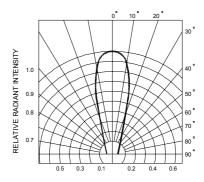


Fig.6 RADIATION DIAGRAM





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Reliability Test

Classification	Test Item	Reference Standard	Test Conditions	Result
	Operation Life	MIL-STD-750D:1026 MIL-STD-883D:1005 JIS-C-7021 :B-1	Ta: Under room temperature Test time:1,000hrs IF=Product Recommended IF	0/32
Endurance Test	High Temperature High Humidity Storage	MIL-STD-202F:103B JIS-C-7021 :B-11	Ta:85±5°C RH:90%-95% Test time:240hrs	0/32
	High Temperature Storage	MIL-STD-883:1008 JIS-C-7021 :B-10	Ta:100±5℃ Test time:1,000hrs	0/32
	Low Temperature Storage	JIS-C-7021 :B-11	Ta: -40±5℃ Test time=1,000hrs	0/32
Environmental Test	Temperature Cycling	MIL-STD-202F:107D MIL-STD-750D:1051 MIL-STD-883D:1010 JIS-C-7021 ;A-2	Ta:-35 \pm 5 $^{\circ}$ C ~25 \pm 5 $^{\circ}$ C ~85 \pm 5 $^{\circ}$ C ~25 \pm 5 $^{\circ}$ C 30min 5min 30min 5min	0/32
	Thermal Shock	MIL-STD-202F:107D(1980) MIL-STD-750D:1051(1995) MIL-STD-883D:1011(1991)	Ta:- $45\pm5^{\circ}$ C ~+ $85\pm5^{\circ}$ C 20min 20 min Time: 40min/cycle 10cycle	0/32
	Wetting balance	MIL-STD-883:2003 MIL-STD-202F:208D MIL-STD-883D:2003	Ta:230±5°C Time:5±0.5s	0/32
	Solder Resistance	MIL-STD-202F:210A MIL-STD-883D:1011 JIS-C-7021 :A-1	Ta:260±10°C Time:10±1s	0/32

Judgment criteria of failure for the reliability

Measuring items	Symbol	Measuring conditions	Judgment criteria for failure
Forward voltage	$V_{F}(V)$	I _F =20mA	Initial Level*1.1
Reverse current	I _R (uA)	V _R =5V	Over U*2
Luminous intensity	Iv (mcd)	I _F =20mA	Initial Level*0.7

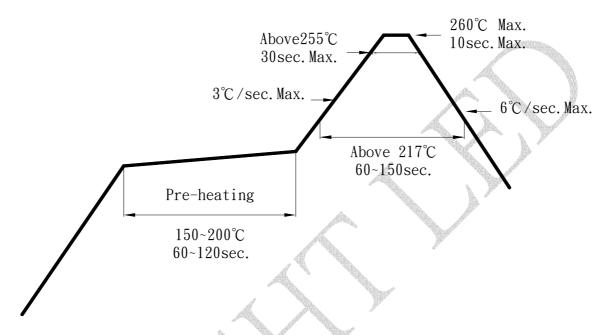
Note: 1.U means the upper limit of specified characteristics.

2. Measurment shall be taken between 2 hours and after the test pieces have been returned to normal ambient conditions after completion of each test.



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●IR-Reflow Soldering



- 1. Avoid any external stress applied to the resin while the LEDs are at high temperature, especially during soldering.
- 2. Avoid rapid cooling or any excess vibration during temperature ramp-down process
- Although the soldering condition is recommended above, soldering at the lowest possible temperature is feasible for the LEDs

■ IRON Soldering



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Notes for designing:

Care must be taken to provide the current limiting resistor in the circuit so as to drive the BRIGHT LEDs within the rated figures. Also, caution should be taken not to overload BRIGHT LEDs with instantaneous voltage at the turning ON and OFF of the circuit.

When using the pulse drive care must be taken to keep the average current within the rated figures. Also, the circuit should be designed so as be subjected to reverse voltage when turning off the BRIGHT LEDs.

Storage:

In order to avoid the absorption of moisture, it is recommended to solder BRIGHT LEDs as soon as possible after unpacking the sealed envelope.

If the envelope is still packed, to store it in the environment as following:

- (1) Temperature : 5° C 30° C (41° F)Humidity : RH 60% Max.
- (2) After this bag is opened, devices that will be applied to infrared reflow, vapor-phase reflow, or equivalent soldering process must be:
- a. Completed within 168hours.
- b. Stored at less than 30% RH.
- (3) Devices require baking before mounting, if: (2) a or (2) b is not met.
- (4) If baking is required, devices must be baked under below conditions: 48 hours at $60^{\circ}\text{C}\pm3^{\circ}\text{C}$.

Package and Label of Products:

- (1) Package: Products are packed in one bag of 1500 pcs and a label is attached on each bag.
- (2) Label:

